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PATENT
29926/38060

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Sung-Kwon Lee and
Sang-Ik Kim

Serial No.: 10/066,849

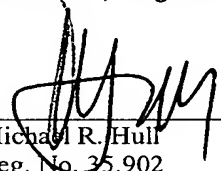
Filed: February 4, 2002

For: Method for Manufacturing Multi-
Level Interconnections with Dual
Damascene Process

Group Art Unit: 1756

Examiner: John S. Ruggles

I hereby certify that this paper and the
documents referred to as enclosed
therewith are being deposited with the
United States Postal Service as first class
mail, postage prepaid, on April 26, 2004,
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AMENDMENT AFTER FINAL (37 C.F.R. § 1.116)

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Commissioner for Patents
P.O. Box 1450
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Sir:

In response to the final office action mailed on February 25, 2004, please
amend the above-identified patent application as follows.

Amendments to the specification begin on page 2 of this paper.

Amendments to the claims begin on page 4 of this paper.

Amendments to the abstract begin on page 7 of this paper.

Remarks begin on page 8 of this paper.